BGF111 TV-Out Filter and ESD Protection

Small Signal Discretes



Never stop thinking

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BGF111

Revision History: 2008-05-28, V2.0

Previous Version: 2007-04-26

Page	Subjects (major changes since last revision)
All	Preliminary status removed



BGF111

Features

- TV-Out Filter
- Wafer level package with SnAgCu solder balls
- Integrated ESD protection up to 15 kV contact discharge according to IEC61000-4-2
- · Low bias voltage dependency of low pass frequency
- RoHS and WEEE compliant package



WLP-4-1-3D



Description

BGF111 is a 75 Ω TV-Out filter with low pass characteristic offering a high stop band attenuation up to 6 GHz in mobile phone, consumer and IT applications. Wafer technology is optimized to provide low variation of the low pass frequency versus bias voltage. ESD protection at both pins exceeds 15 kV contact discharge according to IEC61000-4-2. The wafer level package is a green leadfree package with a size of only 0.75 mm x 0.75 mm and a total height of 0.6 mm.

Туре	Package	Marking	Chip
BGF111	WLP-4-1	11	N0724

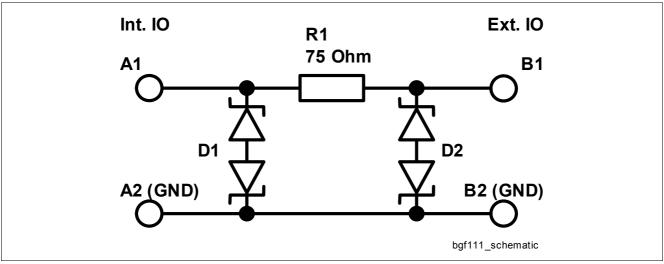
Table 1Maximum Ratings

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Voltage at all pins to GND		0	-	5	V	_
Operating temperature range	T _{OP}	-40	-	85	°C	_
Storage temperature range	T _{STG}	-65	-	150	°C	_
DC current A1 to B1	I _{max}	_	-	35	mA	_
Electrostatic Discharge According to II	EC61000-4-2	1				
Contact discharge between all pins	V _{ESD}	-15	-	+15	kV	-

Table 2Electrical characteristics at $T_A = 25^{\circ}C$

Parameter	Symbol	Values			Unit	Note /
		Min. Typ	Тур.	Max.	-	Test Condition
Resistor R1	<i>R</i> ₁	71.25	75	78.75		_
Leakage currents, A1 or B1 to GND	I _R	-	0.1	120	nA	V_{R} = ±3 V
		-	0.1	120	μA	V_{R} = ±14 V
Line capacitance to GND	CL	-	44	-	pF	<i>V</i> = 0 V
Insertion loss at 0 V bias voltage						<i>f</i> = 0.8 2 GHz,
Pin A1 to B1	IL	-	30	-	dB	$Z_{S} = Z_{L} = 75 \Omega$







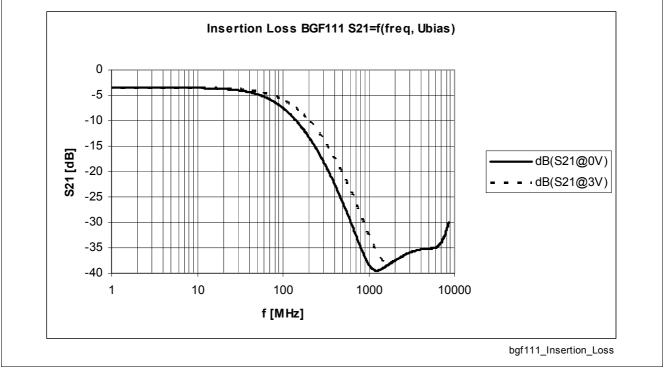
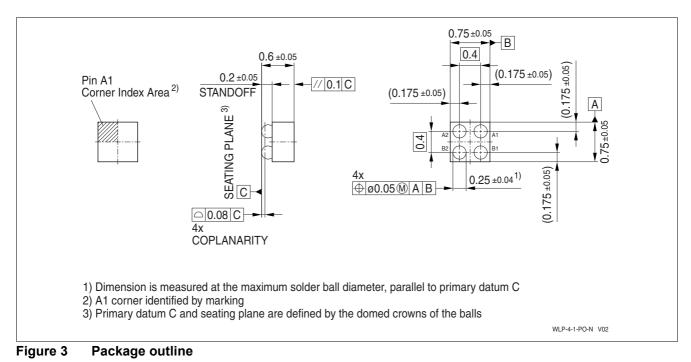


Figure 2 Insertion loss as function of bias voltage, $Z_s = Z_L = 75 \Omega$



BGF111

Package Outline



Tape for BGF111

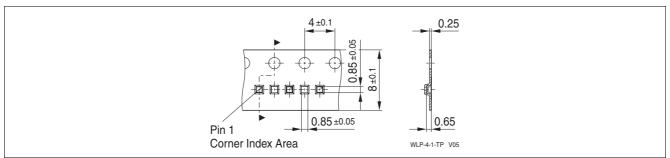


Figure 4 Tape for BGF111 / WLP-4-1

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.